IPC ASSOCIATION CONNECTION ELECTRONICS INDUSTRIE	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				*	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfg Information			
upplier Inform										,		<u> </u>			
Company name*			Company unique ID			Ţ	Unique ID Authority				Respo	Response Date*			
nsemi											2025-0	2025-06-04			
Contact Name		Title - Contact			I	Phone - Contact*			Email	Email - Contact*					
Product-Env-Stew	ards		Product Enviro Compliance				NA			Produ	Product-Env-Stewards@onsemi.com				
Authorized Representative*			Title - Representative			I	Phone - Representative*			Email	Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance				NA			Produ	Product-Env-Stewards@onsemi.com				
Request	Requester Item Number Mfr Iter		Number Mfr Item Name			Effective Date	e Vers	ion	Manufacturing Site		Weight*	UOM	Unit Type		
		MT9V12 DR	8IA3XTC-	VGA 1/4 SOC			2025-06-04			MY5		186.0	mg	Each	
<b>Ianufacturing</b>	Proccess Informati	on													
Terminal Plating / Grid Array Material Terminal Base Alloy			Alloy	I-STD-020 MS	L Rating	Peak Pro	cess Bod	ly Temperati	are Max Time at P	eak Temper	rature Num	ber of Reflow Cyc	cles		
SnAgCu		C	CU Alloy 3			260		С	30	sec	onds 3				
omments															
TTENTION: MS	L 3 Rated item requires	Bake and D	ry Pack (after	r electrical test)											
or more informati	on regarding material c	omposition ]	please refer to	page 3									·	·	

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	26.39	mg		Misc.	proprietary data		0.1003	mg
			Supplier	Silicon (Si)	7440-21-3		26.0285	mg
			Supplier	Aluminum (Al)	7429-90-5		0.2613	mg
Die Attach	2.2	mg	Supplier	Bisphenol A_Epichlorohydrin Polymer	25068-38-6		0.825	mg
			Supplier	Ethylene Glycol	107-21-1		0.022	mg
			Supplier	Sulfonium (Thiodi-4,1-phenylene)	89452-37-9		0.066	mg
			Supplier	Modified Silicon Dioxide (SiO2)	67762-90-7		0.462	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.825	mg
Imaging Lens	25.2	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		1.26	mg
			Supplier	Sodium Monoxide (Na2O)	1313-59-3		1.26	mg
			Supplier	Boron Trioxide (B2O3)	1303-86-2		1.26	mg
			Supplier	Zinc Monoxide (ZnO)	1314-13-2		1.26	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		0.126	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		1.26	mg
			Supplier	Potassium Monoxide (K2O)	12136-45-7		1.26	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		17.514	mg
Lid Attach	1.45	mg	Supplier	Bisphenol A_Epichlorohydrin Polymer	25068-38-6		0.145	mg
			Supplier	Filler (SiO2)	68909-20-6		0.145	mg
			Supplier	Other Additive Agents	Proprietary Data		0.145	mg
			Supplier	Epoxy Prepolymer	Proprietary Data		0.435	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.58	mg
Mold Compound-Black	65.64	mg		Phenolic Resin	proprietary data		9.846	mg
			Supplier	Oxirane	39817-09-9		9.846	mg
			Supplier	1,4-Bis(2,3-epoxypropoxy)butane	2425-79-8		1.9692	mg
			Supplier	Carbon Black (C)	1333-86-4		0.6564	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		42.0096	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		1.3128	mg
Solder Ball	26.34	mg	Supplier	Silver (Ag)	7440-22-4		0.7902	mg
			Supplier	Tin (Sn)	7440-31-5		25.4181	mg
			Supplier	Copper (Cu)	7440-50-8		0.1317	mg
Substrate and Solder Mask	38.5	mg	Supplier	Fiber Glass (SiO2)	65997-17-3		8.1582	mg

			Supplier	Inorganic Filler of Solder Mask_Talc (Mg3Si4O10(OH)2)	14807-96-6	0.5043	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9	0.1271	mg
			Supplier	Acetophenone Derivative	Proprietary Data	0.7546	mg
			Supplier	Carbon Black (C)	1333-86-4	0.1271	mg
			Supplier	2,4-Diethyl-9H-thioxanthen-9-one (DETX)	82799-44-8	0.1271	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2	3.7422	mg
			Supplier	Solvent Naphtha (Solvent oil)	64742-94-5	1.5092	mg
			Supplier	Bismaleimide Triazine resin	Proprietary Data	1.2936	mg
			Supplier	Copper (Cu)	7440-50-8	18.2528	mg
			Supplier	Barium Sulfate (BaSO4)	7727-43-7	3.9039	mg
Wire Bond - Au	0.28	mg	Supplier	Gold (Au)	7440-57-5	0.28	mg